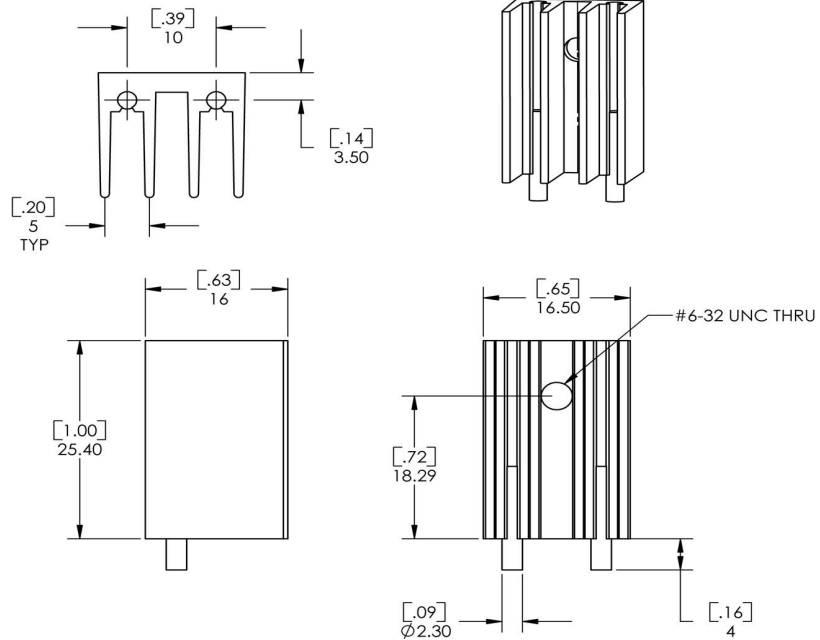
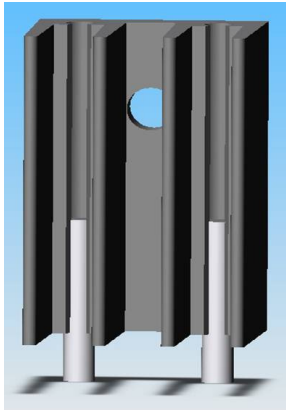


Board Level Heat Sinks



P/N: 412310B02500



PRODUCT SPECIFICATIONS

- Devices: TO-218 & TO-220
- Size: 16.0 x 16.5 x 25.4 mm
- Material: Aluminum
- Type: Extruded
- PCB Mounting: Solderable Pins
- Finish: Black Anodized
- Package: Bulk
- Accessories: Hardware & Thermal Interface Material

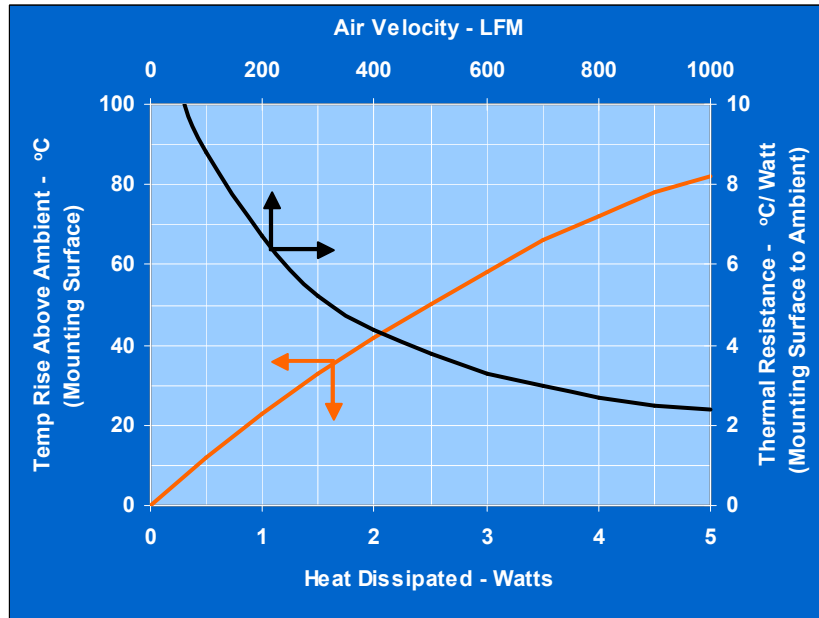
FEATURES & BENEFITS

- Tapped Hole for Device Attachment
- Vertical Mounting via Solderable Pins
- RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Plating
- Specialized Body Configurations
- Contact Applications Engineering



TO-218 & TO-220

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